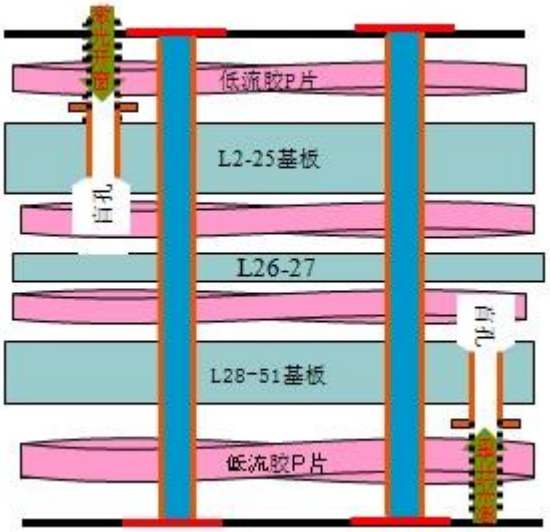
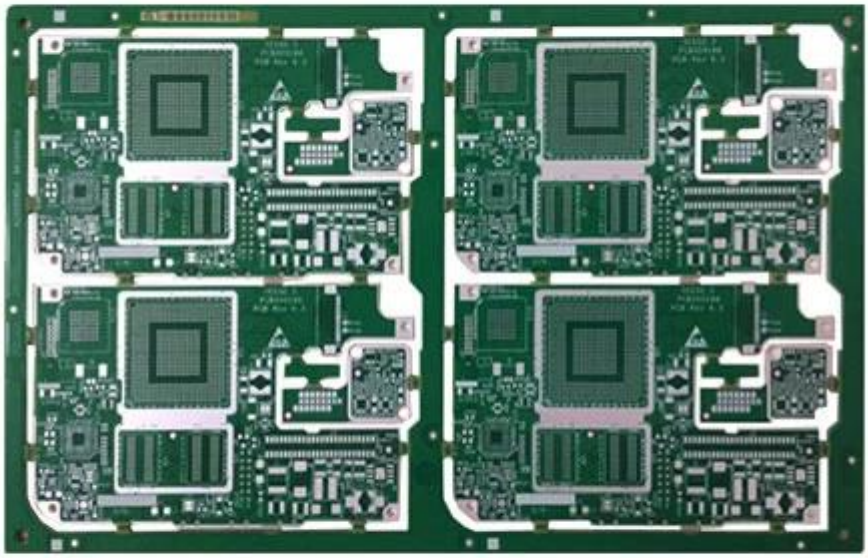
COPPER PLATE HOLES MINIMUM .025 AVG, .020 MIN.. HOLES MAY NOT BE PLUGGED
Special requirement:ENIG, Impedance: Tol: +/-7%, Press fit hole

Pack with colorless transparent bubble film ,25 PCS/ bag, put desiccant in flank, put humidity indicator card on top side

Layer structure



O-LEADING
To Be Reliable, To Be Valuable



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PCB with imedance control, Printed circuit board in china